





### Progress on the Aberystwyth Electron Counting Array

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# Overview

- Technology Overview
- Long Array Development
- Control Electronics Development
- Application to Diamond Contact Formation







## **Detector Technology Overview**

- Readout Device for Microchannel Plate
- Custom ASIC
  - Linear Array of Collection Anodes
  - Amplifier Discriminators
  - 16-bit Counters & Readout Circuitry
  - Ceramic Substrate & MCP Holder
- 'Bed-of-Nails' mounting & Feedthrough
- Floating Control Electronics (ex vacuum)







#### **Long Array Development**

- Current array
  - 768 anodes
  - 19.2mm x 3mm
- New Array
  - New Electron Analyser (SPECS PhoiBOS 100)
  - 1536 anodes
  - 38.4mm x 5mm







## Long Array Technology Challenges

- Yield
  - Not an issue (Current device yields at 90%)
- Reticle Size
  - Standard 20mm x 20mm reticle
  - Need 'stitched' design (Left + Right)
  - No active devices across stitch boundaries
  - Tighter Design Rules over stitch boundary







# Long Array Stitching









# Long Array Stitching









## Long Array Stitching









# Wafer with 40mm detector chips



40mm detector20mm detectorTest structures









# **Control Electronics Development**

- ≈ 2kV across MCP ⇒ Floating readout system
  - TCP/IP over fibre optic (10 Base F)
  - Data Acquisition
  - Gate Timing
- Existing system
  - Based on ipEngine (Brightstar Engineering)
  - Programmed in C
  - $\approx 1.5$ ms/frame (768 pixels @ 2us/pixel)
- In development:
  - Based on National Instruments cRIO
  - Labview programmable
  - $\approx 0.75$  ms/frame (1us/pixel)
  - Easily re-programmed for special applications







### **Control Electronics Development**









# **Detector Applications**

- In-situ study of surface processes:
  - Contact Formation
  - Thin Film Growth
- In situ XPS/PES
- Heated stage (up to 1400 °C)
- K-cells + shutter
- CLAM4 Analyser (Lab & SRS)







### **Contact Formation on Diamond**

- Important for Diamond based devices
- Not predictable
  - Ohmic Contact
  - Shottky Diode
  - Graphitisation
- Depends on
  - Metal
  - Substrate Doping
  - Surface Termination
  - Temperature
  - Etc, etc







# **Contact Formation on Diamond**

- Study by Real Time PES/XPS Lab-based (300W MgKα)
- Single crystal, B doped, p-type <100> CVD
- Deposit Al with k-cell
- Anneal
- Monitor peak intensity & position for C1s
- D. A. Evans, O. R. Roberts, A. R. Vearey-Roberts, et al., Applied Physics Letters 91, 132114 (2007).







#### C1s core peak during growth









#### C1s core peak during anneal











#### Real-time monitoring of organic thin film growth









#### Real-time monitoring of organic thin film growth

- Thin film morphology
- Interface Energetics
- Interface chemistry

• Fast – high throughput



# **CAFMaD**





# **Into the Future**

- Eliminate Multiple Triggering
  - Charge Cloud Spreading
  - Degrades Spectrum
  - Voting Circuit
  - Post-doc
  - See poster
- Commercialisation

- 2 Dimensions
  - Spatial + Energy
  - Angle + Energy
    - Depth + Energy
  - High Flux / Short Pulse
    Applications
    - ➔ Spread electrons over
    - larger area







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